

N-Channel Enhancement-Mode MOSFET

Designed for handheld two-way radio applications with frequencies from 136 to 941 MHz. The high gain, ruggedness and Broadband performance of this device make it ideal for large-signal, common-source amplifier applications in handheld radio equipment.

**136–941 MHz, 0.5 W, 3.7 V
BROADBAND RF
POWER TRANSISTOR**

Typical Broadband EVB Performance ($I_{DQ}=200\text{mA}$, $T_A = 25^\circ\text{C}$, CW)

Freq.	V_{DD}	Gmax	Pout		PAE
[MHz]	[V]	[dB]	[dBm]	[Watts]	[%]
440	3.7	19.6	28.0	0.6	60.0
	4.5	20.0	29.6	0.9	60.1
	6.0	20.3	32.1	1.6	60.9

Capable of Handling 20:1 VSWR @ 6.0Vdc, 1.5Watts, CW

Features

- Characterized for Operation from 136 to 941 MHz
- Unmatched Input and Output Allowing Broad Frequency Range Utilization
- Integrated ESD Protection
- Broadband – Full Power Across the Band
- Exceptional Thermal Performance
- Extreme Ruggedness

Typical Applications

- Output Stage VHF Band Handheld Radio
- Output Stage UHF Band Handheld Radio
- Output Stage for 700–800 MHz Handheld Radio
- Driver for 10–1000 MHz Applications

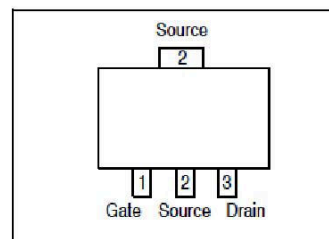
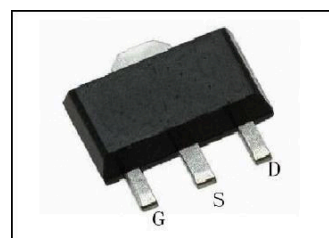


Figure 1. Pin Connections

HPL09S0P5N

RF Power Field Effect Transistor

Table1. Maximum Ratings

Rating	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	-0.5, +20	Vdc
Gate-Source Voltage	V_{GS}	-0.5, +8	Vdc
Operating Voltage	V_{DD}	0, +6	Vdc
Storage Temperature Range	T_{stg}	-65 to +150	°C
Case Operating Temperature	T_C	-40 to +150	°C
Operating Junction Temperature	T_J	-40 to +150	°C
Power Dissipation @ $T_C=25^{\circ}C$	PD	3	W

Table 2. ESD Protection Characteristics

Test Methodology	Class
Human Body Model (per JESD22--A114)	2, passes 2500 V
Machine Model (per EIA/JESD22--A115)	A, passes 100 V
Charge Device Model (per JESD22--C101)	IV, passes 2000 V

Table 3. Electrical Characteristics ($T_A=25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Typ.	Max	Unit
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Off Characteristics

Gate-Source Leakage Current ($V_{GS}=5V_{dc}$, $V_{DS}=0V_{dc}$)	I_{GSS}	-	-	500	nAdc
Zero Gate Voltage Drain Leakage Current ($V_{DS}=16V_{dc}$, $V_{GS}=0V_{dc}$)	I_{DSS}	-	-	1	μ Adc
Zero Gate Voltage Drain Leakage Current ($V_{DS}=3.7V_{dc}$, $V_{GS}=0V_{dc}$)	I_{DSS}	-	-	500	nAdc

On Characteristics

Gate Threshold Voltage ($V_{DS}=3.7V_{dc}$, $I_D=1mA$)	$V_{GS(th)}$	1.2	1.4	1.6	Vdc
Gate Quiescent Voltage ($V_{DD}=3.7V_{dc}$, $I_D=200mA$ Measured in Functional Test)	$V_{GS(Q)}$	1.7	2.2	2.5	Vdc
Drain-Source On-Voltage ($V_{GS}=8V_{dc}$, $I_D=200mA$)	$V_{DS(ON)}$	-	0.12	-	Vdc

Dynamic Characteristics

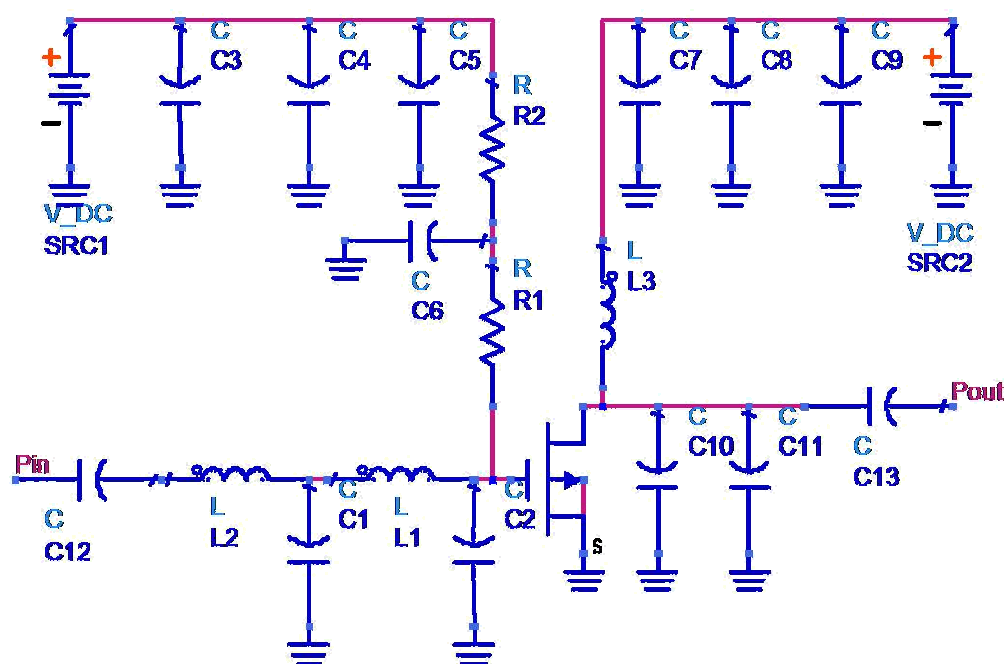
Reverse Transfer Capacitance ($V_{DG}=3.7V$, Level=30mVac@1MHz)	C_{rss}	-	1.1	-	pF
Output Capacitance ($V_{DS}=3.7V$, Level=30mVac@1MHz)	C_{oss}	-	5.0	-	pF
Input Capacitance ($V_{GS}=5V$, Level=30mVac@1MHz)	C_{iss}	-	17.4	-	pF

Typical Performances

 (In DuSemi Narrowband Test DEMO, 50 Ohm system)

Frequency=440MHz, $V_{DD}=3.7V_{dc}$, $I_{DQ}=200mA$, $P_{in}=8dBm$, $T_A=25^{\circ}C$

Output Power	P_{out}	-	0.5	-	Watts
Power Gain	G_{PS}	-	20	-	dB
Drain Efficiency	η_D	-	60	-	%

Broadband Evaluation Circuit (f = 400 -470MHz)

Test Circuit Component Layout

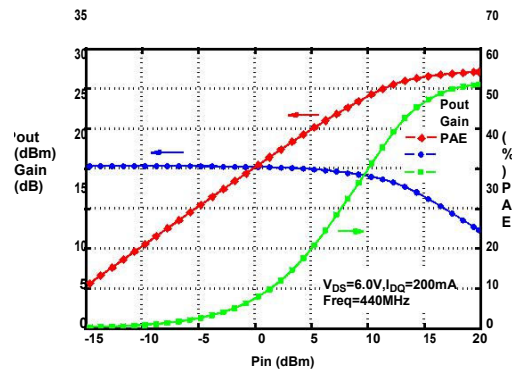
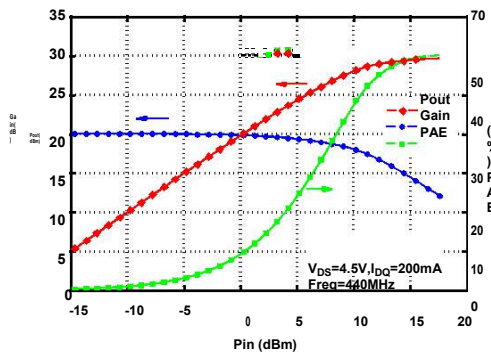
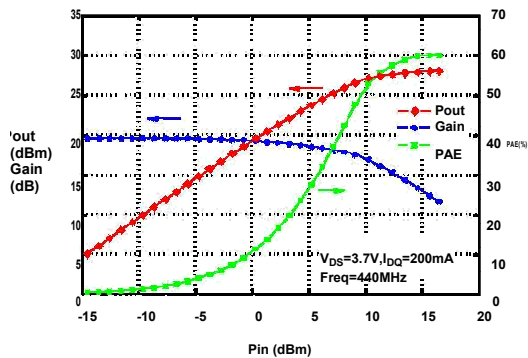
Table 5. Test Circuit Component Designations and Value

Part	Description	Part Number	Manufacturer
R1	470Ohm	—	—
R1	6.8KOhm	—	—
L1,L2	3.9nH	—	—
L3	8 Turns D: 0.5 mm, φ 2.4 mm Enamel Wire	—	—
C5, C6,C7,C12,C13	100pF Chip Capacitors	GQM21P5C1H101JB01	Murata
C1, C2	18pF Chip Capacitors	GRM1885C1H201JA01	Murata
C4,C8	1000pF Chip Capacitors	GRM1885C1H102JA01	Murata
C3,C9	10uF,25VChip Capacitors	—	—
C10	9pF Chip Capacitors	—	Murata
C11	4.3pF Chip Capacitors	—	Murata
PCB	FR-4 ,1.6mm,ε _r 4.5	—	—

TYPICAL CHARACTERISTICS

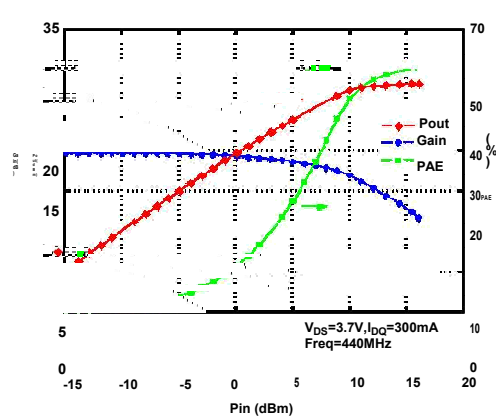
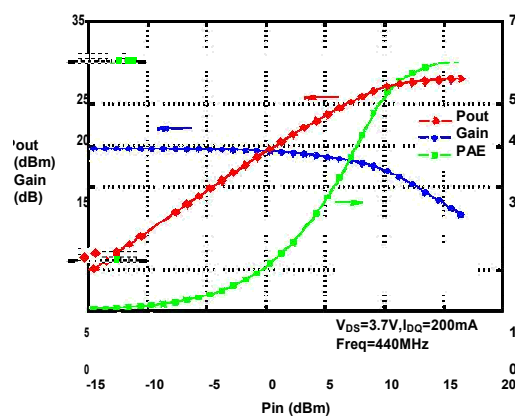
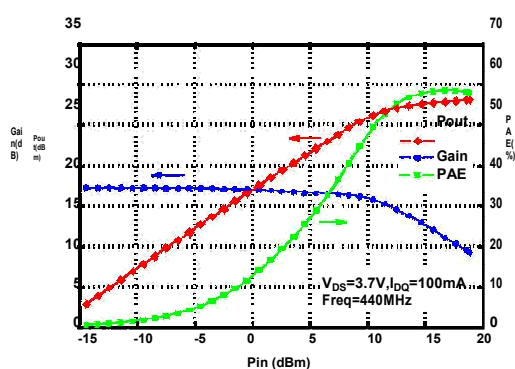
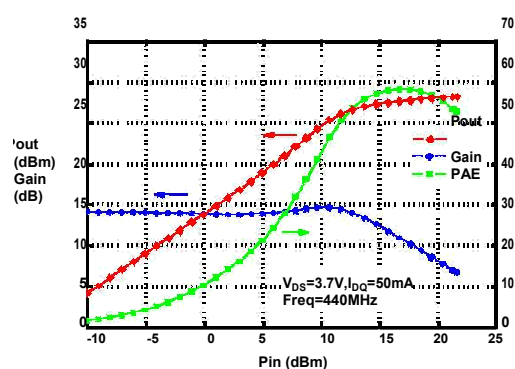
1、Power Gain, Drain Efficiency and Output Power versus input power@440MHz

Freq	V_{DS}	$I_{DS(Q)}$	Pout		Gain	η_D
[MHz]	[V]	[mA]	[dBm]	[Watts]	[dB]	[%]
440	3.7	200	28.0	0.6	19.6	60.0
	4.5		29.6	0.9	20.0	60.1
	6.0		32.1	1.6	20.3	60.9



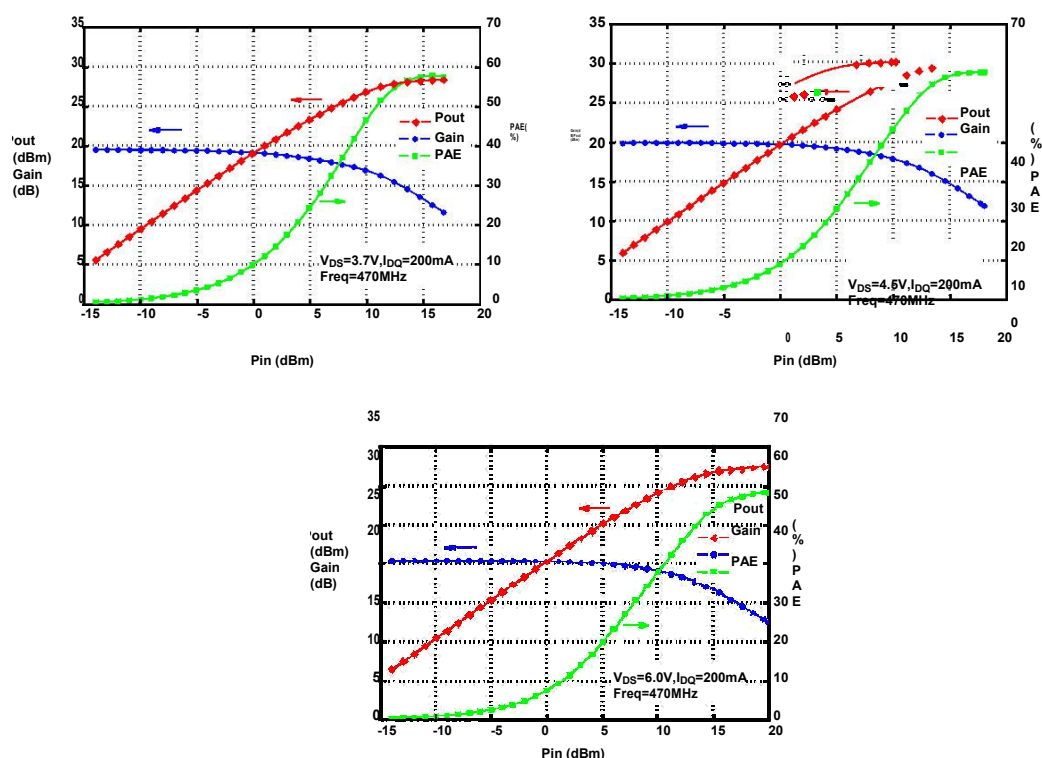
2、Power Gain, Drain Efficiency and Output Power versus Gate Quiescent Current @440MHz

Freq	V _{DS}	I _{DS(Q)}	P _{out}		Gain	PAE
[MHz]	[V]	[mA]	[dBm]	[Watts]	[dB]	[%]
440	3.7	50	28.2	0.6	14.2	58.3
		100	28.0	0.6	17.3	58.6
		200	28.0	0.6	19.6	60.0
		300	28.2	0.6	20.1	60.6



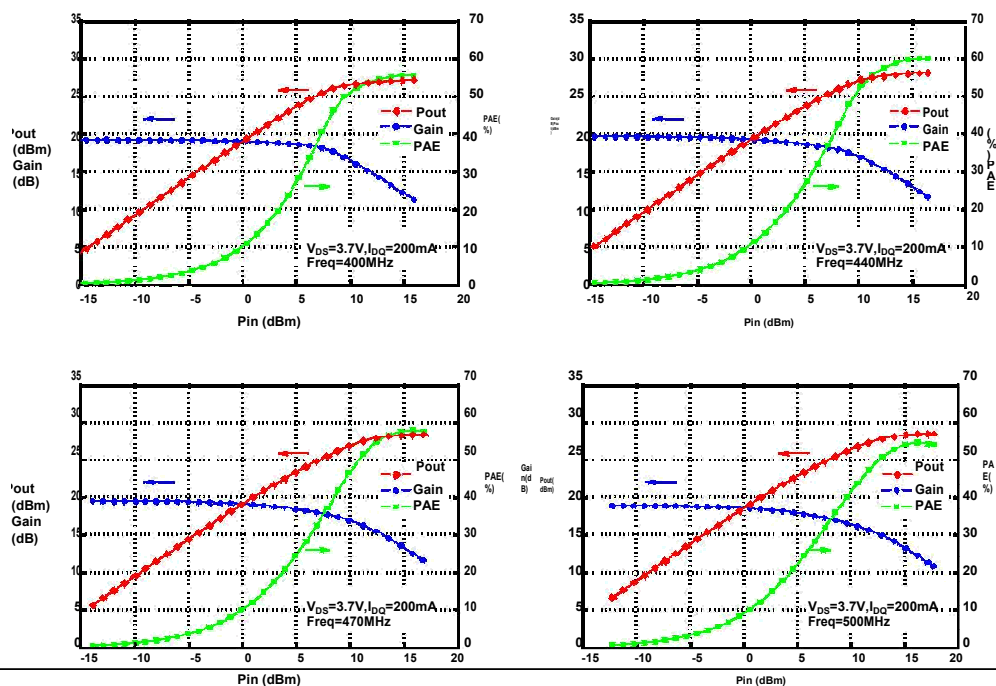
3、Power Gain, Drain Efficiency and Output Power versus input power@470MHz

Freq	V _{DS}	I _{DS(Q)}	P _{out}		Gain	PAE
[MHz]	[V]	[mA]	[dBm]	[Watts]	[dB]	[%]
470	3.7	200	28.3	0.6	19.5	57.8
	4.5		29.9	0.9	19.9	57.8
	6.0		32.4	1.7	20.4	58.1

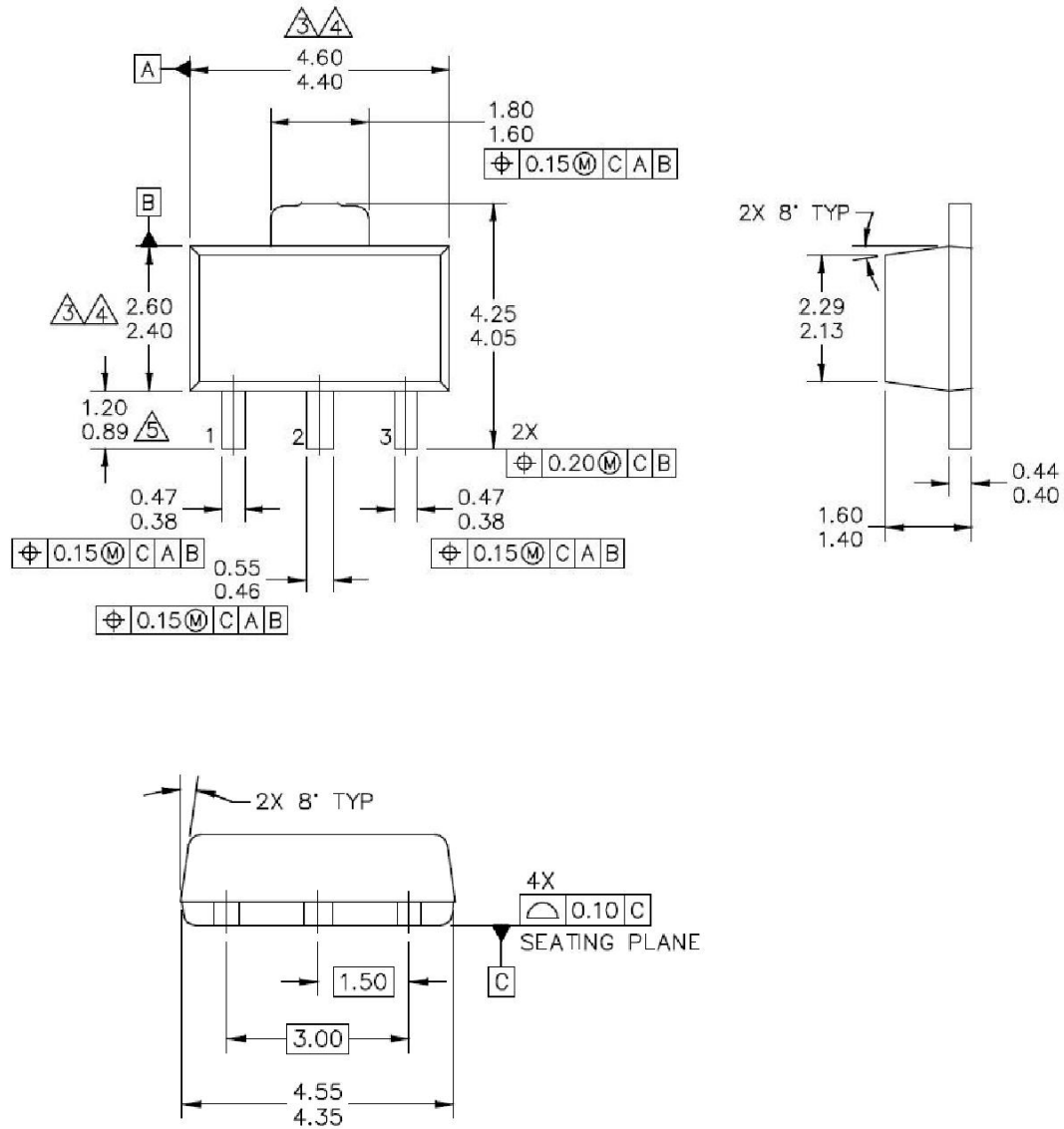


4、Power Gain, Drain Efficiency and Output Power versus Frequency

Freq.	V _{DS}	I _{DS(Q)}	Pout		Gain	PAE
[MHz]	[V]	[mA]	[dBm]	[Watts]	[dB]	[%]
400	3.7	200	27.1	0.5	19.2	55.4
440			28.0	0.6	19.6	60.0
470			28.3	0.6	19.5	57.8
500			28.4	0.7	18.9	54.5



PACKAGE DIMENSIONS



REVISION HISTORY

The following table summarizes revisions to this document.

Revision	Date	Description
1.0	May 2018	Initial Release of Data Sheet